



THE DANISH NATIONAL SPACE CENTER IS A PART OF THE NEW TECHNICAL UNIVERSITY OF DENMARK

# Proton Testing of Micro Advanced Stellar Compass TEC-QCA Support Activity to PROBA-II

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# PROBA-II

Spacecraft technology miniaturisation

- Attitude measurement sensors
- Attitude control systems
- Integrated data handling
- Enhanced payload

and others

### Miniature: Micro Advanced Stellar Compass





### **Micro Advanced Stellar Compass**

- The micro-Advanced Stellar Compass (µASC) is a highly advanced and fully autonomous star tracker designed to connect 4 camera heads, developed and produced by the Measurement and Instrumentation Systems (MIS) Section of the Ørsted Department at the Technical University of Denmark (DTU).
- The µASC attitude sensor delivers in real-time up to 32 real time attitudes per second a three-axes attitude of its reference frame with respect to the J2000 inertial reference frame at any user specified epoch.
- The data delivered by the µASC can directly be used to control the attitude of the satellite.





### **Test Facilities**

- The SEU tests were performed at the Paul Scherrer Institute 14-15 February 2006 by the Space Instrumentation Group at Ørsted•DTU, Denmark with participation from ESA/ESTEC
- The Danish National Space Center would like to thank ESA for the economic support and kind assistance (and time) from Dr. Reno Harboe Sørensen and Dr. Frederic Teston from ESA.





# COTS: ASC and $\mu\text{ASC}$

- Compatibility with design
- Observation
- Time
- Study
- Total dose tests
- Irradiation with particles
- Damage investigation





### Latch-Up Protection

- Several latch-up protection circuits for groups of components operating together
- Increased current consumption mean shut-down and reboot of the entire system to prevent destruction.
- Latch-up protection circuits proved their efficiency with success during heavy ion tests.





### **Correction Mechanisms**

- EEC protection on FLASH RAM and SDRAMs
- 2 bits detection, 1 bit correction is used
- Double bit flips means system reboot
- SEUs as bit flips are logged during tests together with the bit addresses





# **System Functionality**

- All components on board
- Size of test board
- Unintentional irradiation
- Current consumption & System response
- Cross sections

- Irradiation sequence
- Test board set-up
- Proton energy
- Versus single
  component response
- Selected components





#### Layout: Board Size and Set-Up







### **Collimator - and Unintentional Irradiation**







### **Beam Parameters for PSI tests**

- 15mm planar beam
- Mean flux 7.2 E<sup>7</sup> /cm<sup>2</sup>/s
- Mean fluence 9.3 E<sup>9</sup> /cm<sup>2</sup>
- Mean dose 500 rad(Si)
- Proton energy 223 MeV (32 MeV)
- HY57V651620BLTC-10S: 38, 50, 72, 101,151
  210 and 223 MeV





### **Components w\ Special EGSE Test Programs**

OR2T06A5T144	Lattice Semiconductor	FPGA		
ELANSC520-100	AMD	CPU		
HY57V651620BLTC-10S	Hynix / Hyundai	64 Mbit SDRAM		
AT49BV1614T-11TI	ATMEL	FLASH		
AT27C512R	ATMEL	64K * 8 OTP EPROM		
MAX1081AEUP	MAXIM	8 chn. 10 bit ADC		
MAX1444EHJ	MAXIM	10 bit ADC		
MAX3031EESE	MAXIM	Quad Line Driver		
MAX3096ESE	MAXIM	Quad Line Receiver		
LT1242IS8	Linear Technology	Pulse Width Modulator		





# **Star Tracking Using 9-Star-Stimulator**

- Stimulator update mode
- House keeping frequency 1 Hz
- Bitwash frequency 1/min
- Debug to trap RAM bitflips
- Exception handling logging
- Watchdog timeout 2s for rapid recovery

### LT1242IS8, ELANSC520-100, MAX1081AEUP, HY57V651620BLTC-10S





### Star Tracking Using 9-Star-Stimulator Monitoring Image Statistics

- Stimulator update mode
- House keeping frequency 1 Hz
- Bitwash frequency 1/min
- Debug to trap RAM bitflips
- Exception handling logging
- Watchdog timeout 2s for rapid recovery
- Debug variance flag for monitoring statistics
- OR2T06A5T144, MAX1444EHJ





### **Power Cycling the Instrument**

- Reboot continuously
- Reading from PROM (bootstrap and safe-mode software)
- Reading from Flash (application mode software)
- Attitude packet transmission leads to reboot
- Exception handling logging
- Final reboot after end of irradiation

• AT49BV1614T-11TI, AT27C512R





# Verifying Telemetry Quality

- Special program for test of line driver
- Memory dump
- Performance evaluation based on checksum errors
- Very low telemetry packet size for better statistics (100 bytes)
- No attitude determination: Stand-by mode
- Exception handling logging
- Watchdog timeout 2s for rapid recovery
- MAX3031EESE





## **Verifying Telecommand Quality**

- Special program for test of line receiver
- Continuous House keeping requests at 0.1 Hz
- Performance evaluation based on checksum errors
- No attitude determination: Stand-by mode
- Exception handling logging
- Watchdog timeout 2s for rapid recovery
- MAX3096ESE





## MAX3031EESE MAX3096ESE

- MAX3031 generates the 422 signal levels for the telemetry transmission. The telemetry port was sending continuously during the test, i.e. with a duty cycle of 100% while the debug duty cycle was 5%. No component transmission errors on either of the ports were observed during the test.
- MAX3096 transforms the 422 signal levels for the telecommand interface to low voltage signals. No errors were seen for TC-commands during the test of the MAX3096EESE. However, the test caused a reboot and a high number of SEUs was observed because 1/3 of the area of an adjacent SDRAM was irradiated, too.





### MAX144EHJ and OR2T06A5T144



- No critical signatures in the standard deviation measurements were observed. Slight increase in gain values (AGC level).
- The MAX1444EHJ showed a one-time occurrence of a single minor spike in the centre image (100 by 100 pixels) standard deviation. The spike corresponds to a transient image hotspot.





### HY57V651620BLTC-10S: SEUs & Exceptions

MeV	38	50	72	101	151	210	223	
SEUs	44	74	129	189	435	521	525/606	

- 0D General Protection Error
- 02 Double Bit Flip
- 10 Floating Point Error

MeV	38	50	72		101		151		210		223	
Exc.	0	0	1	0D	1	10	2	02	1	02	7/6	02





### HY57V651620BLTC-10S: Cross Sections







### **Cross Sections: SDRAM and CPU**

- CPU <  $3.3 E^{-10} cm^2/device$
- Reboots observed during test due to exceptions
  0D general protection error concerning RAM read/write procedures
- SDRAM < 4  $E^{-8}$  cm<sup>2</sup>/device
- SDRAM < 1.5  $E^{-15}$  cm<sup>2</sup>/bit





### Occasional SEUs (from SDRAM) Otherwise no effect

- LS1242IS8 Tested twice
- 1 reboot
- MAX1081AEUP
  No latch-ups
  No reboots

- AT27C512R
- AT49BV1614T-11TI

Tested together No reboot problems encountered





#### **Thank You**



#### **Danish Team with ESA/ESTEC**